V35PW60

Vishay General Semiconductor

High Current Density Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

Ultra Low $V_F = 0.31$ V at $I_F = 5$ A



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PIN 2 OHIEATSINK

LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	35 A			
V _{RRM}	60 V			
I _{FSM}	260 A			
V_F at I_F = 35 A (T_A = 125 °C)	0.55 V			
T _J max.	150 °C			
Package	SlimDPAK (TO-252AE)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 1.3 mm
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

MECHANICAL DATA

Case: SlimDPAK (TO-252AE) Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 gualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V35PW60	UNIT	
Device marking code		V35PW60		
Aximum repetitive peak reverse voltage V _{RRM}		60	V	
Maximum average forward rectified current (Fig. 1)	I _{F(AV)} ⁽¹⁾	35	А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	260	А	
Operating junction temperature range	T _J ⁽²⁾	-40 to +150	°C	
Storage temperature range	T _{STG}	-55 to +150	°C	

Notes

⁽¹⁾ With infinite heatsink

 $^{(2)}$ The heat generated must be less than the thermal conductivity from junction to ambient: $dP_D/dT_J < 1/R_{0JA}$

Revision: 12-May-2020

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Document Number: 87687

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ROHS COMPLIANT

HALOGEN

V35PW60



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ELECTRICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum Instantaneous forward voltage	I _F = 5.0 A	7.5 A T _A = 25 °C	V _F (1)	0.42	-	V
	l _F = 17.5 A			0.53	-	
	I _F = 35 A			0.64	0.72	
	I _F = 5.0 A	17.5 A T _A = 125 °C		0.31	-	
	l _F = 17.5 A			0.46	-	
	I _F = 35 A			0.55	0.63	
Reverse current	V _R = 60 V	T _A = 25 °C	I _B ⁽²⁾	-	5	mA
	$V_{\rm R} = 60 \text{ V}$ $T_{\rm A} = 125 \text{ °C}$	'R (=/	30	80		
Typical junction capacitance	4.0 V, 1 MHz	•	CJ	3600	-	pF

Notes

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

 $^{(2)}$ Pulse test: pulse width $\leq 5\mbox{ ms}$

THERMAL CHARACTERISTICS ($T_A = 25 \text{ °C}$ unless otherwise noted)				
PARAMETER	SYMBOL	V35PW60	UNIT	
Typical thermal registeres	R _{0JA} (1)(2)	55	°C/W	
Typical thermal resistance	R _{0JM} ⁽³⁾	1.5		

Notes

⁽¹⁾ The heat generated must be less than thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

- $^{(2)}$ Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ junction to ambient
- $^{(3)}$ Mounted on infinite heat sink; thermal resistance $R_{\theta JM}$ junction-to-mount

ORDERING INFORMATION (Example)					
PREFERRED P/N UNIT WEIGHT (g) PREFERRED PACKAGE CODE		BASE QUANTITY	DELIVERY MODE		
V35PW60-M3/I	0.20	I	4500	13" diameter plastic tape and reel	
V35PW60HM3/I ⁽¹⁾	0.20	ļ	4500	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES ($T_A = 25$ °C unless otherwise noted)

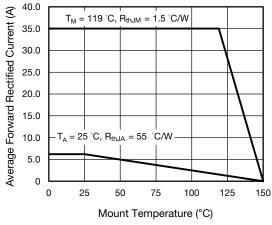


Fig. 1 - Maximum Forward Current Derating Curve

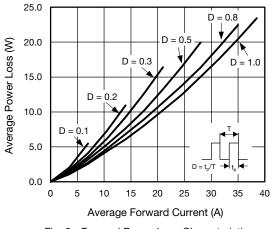


Fig. 2 - Forward Power Loss Characteristics

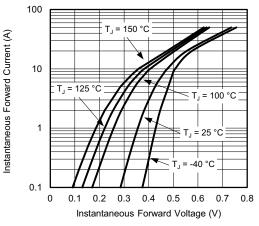
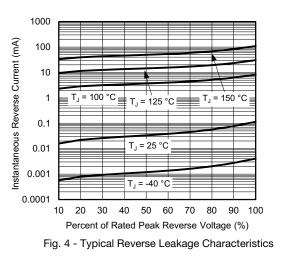
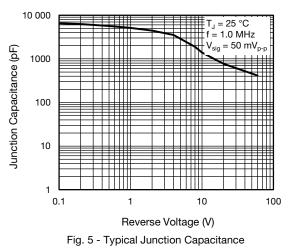


Fig. 3 - Typical Instantaneous Forward Characteristics





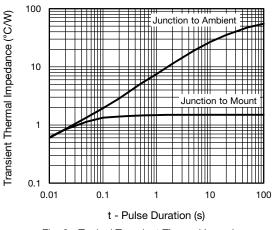


Fig. 6 - Typical Transient Thermal Impedance

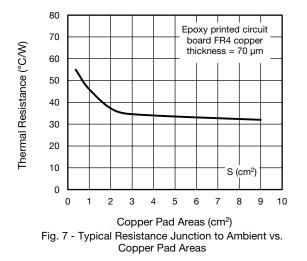
Revision: 12-May-2020

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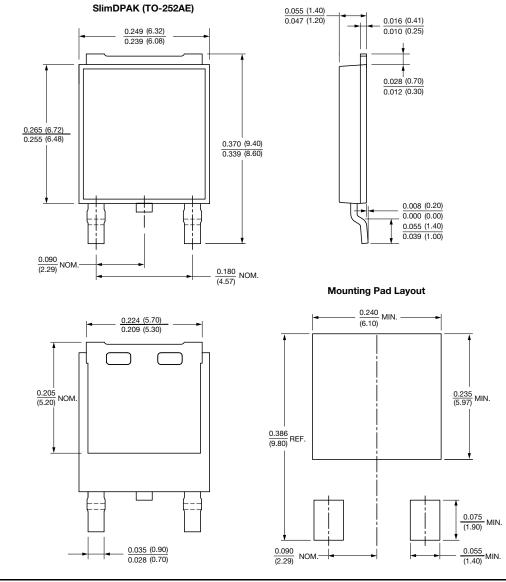
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